SN5427, SN54LS27, SN7427, SN74LS27 TRIPLE 3-INPUT POSITIVE-NOR GATES

SDLS089

 Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs

 Dependable Texas Instruments Quality and Reliability

description

These devices contain three independent 3-input NOR gates.

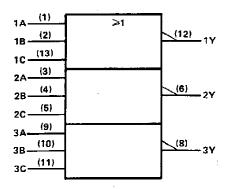
The SN5427 and SN54LS27 are characterized for operation over the full military temperature range of -55 °C to 125 °C. The SN7427 and SN74LS27 are characterized for operation from 0 °C to 70 °C.

FUNCTION TABLE (each gate)

11	VPUT	s	OUTPUT
А	В	С	Y
н	х	×	 Ļ
х	н	X	L
х	х	н	L
L	L	L	H .

logic symbol[†]

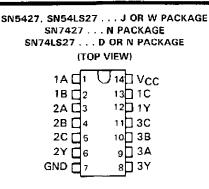
÷,



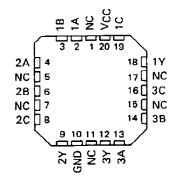
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

DECEMBER 1983-REVISED MARCH 1988

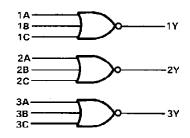


SN54LS27 FK PACKAGE (TOP VIEW)



NC - No internal connection

logic diagram



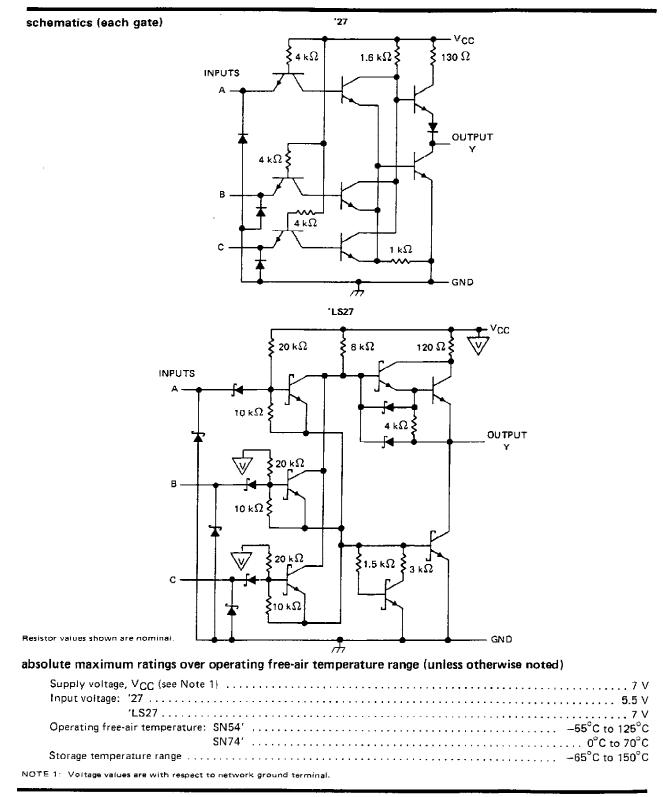
positive logic

 $Y = \overline{A + B + C}$ or $Y = \overline{A} \cdot \overline{B} \cdot \overline{C}$

PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Taxas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



SN5427, SN54LS27, SN7427, SN74LS27 **TRIPLE 3-INPUT POSITIVE-NOR GATES**





POST OFFICE BOX 655012 . DALLAS, TEXAS 75265

recommended operating conditions

			SN5427			\$N7427			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
VGC	Supply voltage	4.5	5	5.5	4.75	5	5.25	v	
VIH	High-level input voltage	2			2			v	
V _{IL}	Low-level input voltage			0.8			0.8	v	
юн	High-level output current			0.8			- 0.8	mΑ	
¦0∟	Low-level output current			16			16	mΑ	
ŤΑ	Operating free-air temperature	- 55		125	0		70	°c	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDIT	10NS +		SN5427		'	UNIT		
TANAMETEN				MIN	TYP ‡	MAX	MIN	түр‡	МАХ	UNTI
Vik	V _{CC} = MIN,	l ₁ = – 12 mA				- 1.5			- 1.5	v
⊻он	V _{CC} = MIN,	V _{IL} = 0.8 V,	I _{OH} = - 0.8 mA	2.4	3.4		2,4	3.4		v
Vol	V _{CC} = MIN,	V _{IH} = 2 V,	I _{OL} = 16 mA		0.2	0.4		0.2	0.4	v
ţ _I	V _{CC} = MAX,	V ₁ = 5,5 V				1			1	mA
ін	V _{CC} = MAX,	V1 = 2.4 V			-	40			40	μA
կլ	V _{CC} = MAX,	Vj = 0.4 V				- 1.6			- 1.6	mA
los §	V _{CC} = MAX			- 20		- 55	- 18		- 55	mA
ICCH	VCC = MAX,	VI = 0 V			10	16		10	16	mA
ICCL	V _{CC} = MAX,	See Note 2			16	26		16	26	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

2

‡ All typical values are at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$. § Not more than one output should be shorted at a time.

NOTE 2: One input at 4.5 V, all others at GND.

switching characteristics, VCC = 5 V, TA = 25° C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	DITIONS	MIN	түр	мах	UNIT
tPLH	A, B or C	v	R _L = 400 Ω,	C1 = 15 pF		10	15	ns
tpHL	A, 5 0 C		··· - 400 32,	of - 19 th		7	11	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



SN54LS27, SN74LS27 TRIPLE 3-INPUT POSITIVE-NOR GATES

recommended operating conditions

		s	SN54LS27			SN74LS27			
	·····	MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
V _{CC} Si	upply voltage	4.5	5	5.5	4.75	5	5.25	v	
V _{IH} H	igh-level input voltage	2			2			v	
VIL La	ow-level input voltage			0.7			0.8	V	
IOH H	igh-level output current			- 0.4			- 0.4	mΑ	
IOL LO	ow-level output current			4			В	mA	
	perating free-air temperature	- 55		125	0		70	°c	

-

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

		TEST CONDITIONS †				SN54LS27				UNIT
PARAMETER						MAX	MIN	TYP ‡	MAX	UNIT
Viк	V _{CC} = MIN.	l _l = 18 mA				- 1.5			- 1.5	v
Vон	V _{CC} = MIN,	V _{IL} = MAX,	l _{OH} ≐ – 0.4 mA	2.5	3.4		2.7	3.4		v
	VCC = MIN,	V _{1H} = 2 V,	loL = 4 mA		0.25	0.4		0.25	0.4	v
VOL	V _{CC} = MIN,	V _{IH} = 2 V,	lOL = 8 mA					0.35	0.5	Ŷ
lj lj	V _{CC} = MAX,	V1 = 7 V	· · · · · · · · · · · · · · · · · · ·			0.1			0.1	mA
Чн	VCC = MAX,	V∣ ≠ 2.7 V				20			20	μA
lι,	V _{CC} = MAX,	V _I ≠ 0.4 V				- 0.4			- 0.4	mA
IOS §	V _{CC} = MAX			- 20		- 100	20		- 100	mA
Іссн	V _{CC} = MAX,	V = 0 V			2	4		2	4	mА
^I CCL	VCC = MAX,	See Note 2			3.4	6.8		3.4	6.8	mA

t For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

* All typical values are at V_{CC} = 5 V, T_A = 25°C. § Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second. NOTE 2: One Input at 4.5 V, all others at GND.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$ (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	түр	МАХ	UNIT	
tplh	A, B or C	v	$R_L = 2 k \Omega, \qquad C_l = 15$	- F		10	15	пs
^t ₽HL	A, B OF C	· · ·		С _L = 15 рF		10	15	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.





PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
JM38510/30302B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30302B2A	Samples
JM38510/30302BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30302BCA	Samples
JM38510/30302BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30302BCA	Samples
JM38510/30302BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30302BDA	Samples
JM38510/30302BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30302BDA	Samples
M38510/30302B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30302B2A	Samples
M38510/30302B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30302B2A	Samples
M38510/30302BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30302BCA	Samples
M38510/30302BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30302BCA	Samples
M38510/30302BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30302BDA	Samples
M38510/30302BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30302BDA	Samples
SN54LS27J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS27J	Samples
SN54LS27J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS27J	Samples
SN74LS27D	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS27	Samples
SN74LS27D	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS27	Samples
SN74LS27DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS27	Samples
SN74LS27DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS27	Samples



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Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74LS27N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS27N	Samples
SN74LS27N	ACTIVE	PDIP	Ν	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS27N	Samples
SN74LS27NSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS27	Samples
SN74LS27NSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS27	Samples
SNJ54LS27FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 27FK	Samples
SNJ54LS27FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 27FK	Samples
SNJ54LS27J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS27J	Samples
SNJ54LS27J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS27J	Samples
SNJ54LS27W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS27W	Samples
SNJ54LS27W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS27W	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <= 1000ppm threshold. Antimony trioxide based flame retardants must also meet the <= 1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.



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PACKAGE OPTION ADDENDUM

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF SN54LS27, SN74LS27 :

• Catalog : SN74LS27

Military : SN54LS27

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications



Texas

STRUMENTS

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*Al	l dimensions are nominal												
	Device	-	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
	SN74LS27DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
	SN74LS27NSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

Pack Materials-Page 1



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PACKAGE MATERIALS INFORMATION

9-Aug-2022



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS27DR	SOIC	D	14	2500	356.0	356.0	35.0
SN74LS27NSR	SO	NS	14	2000	356.0	356.0	35.0

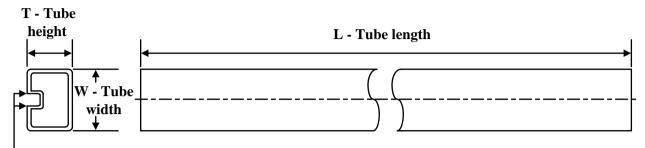
Pack Materials-Page 2

TEXAS INSTRUMENTS

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9-Aug-2022

TUBE



- B - Alignment groove width

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
JM38510/30302B2A	FK	LCCC	20	1	506.98	12.06	2030	NA
JM38510/30302BDA	W	CFP	14	1	506.98	26.16	6220	NA
M38510/30302B2A	FK	LCCC	20	1	506.98	12.06	2030	NA
M38510/30302BDA	W	CFP	14	1	506.98	26.16	6220	NA
SN74LS27D	D	SOIC	14	50	506.6	8	3940	4.32
SN74LS27N	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS27N	N	PDIP	14	25	506	13.97	11230	4.32
SNJ54LS27FK	FK	LCCC	20	1	506.98	12.06	2030	NA
SNJ54LS27W	W	CFP	14	1	506.98	26.16	6220	NA

Pack Materials-Page 3

MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 7,40 5,00 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0°-10° 0,15 0,05 Seating Plane - 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

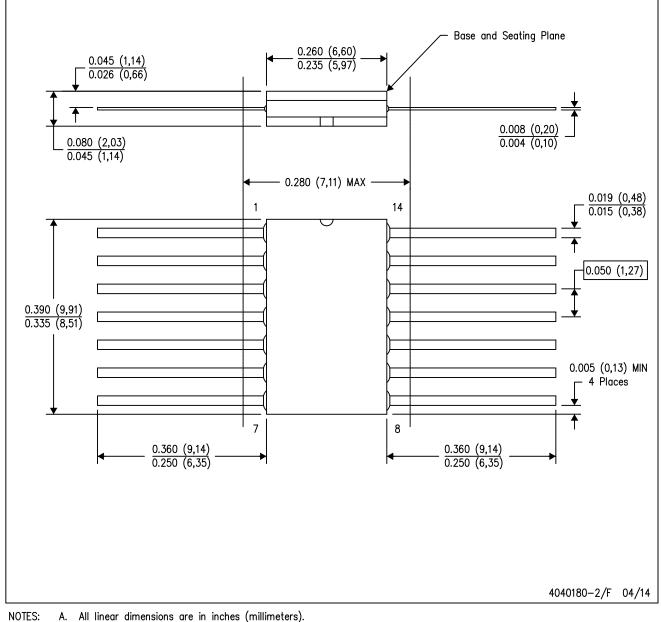
14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
 - В. This drawing is subject to change without notice. C.
 - This package can be hermetically sealed with a ceramic lid using glass frit. D. Index point is provided on cap for terminal identification only.
 - E. Falls within MIL STD 1835 GDFP1-F14



FK 20

8.89 x 8.89, 1.27 mm pitch

GENERIC PACKAGE VIEW

LCCC - 2.03 mm max height

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



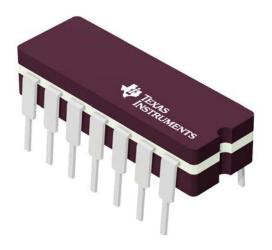


4229370\/A\

GENERIC PACKAGE VIEW

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



4040083-5/G

J0014A



PACKAGE OUTLINE

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



NOTES:

- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
 Falls within MIL-STD-1835 and GDIP1-T14.

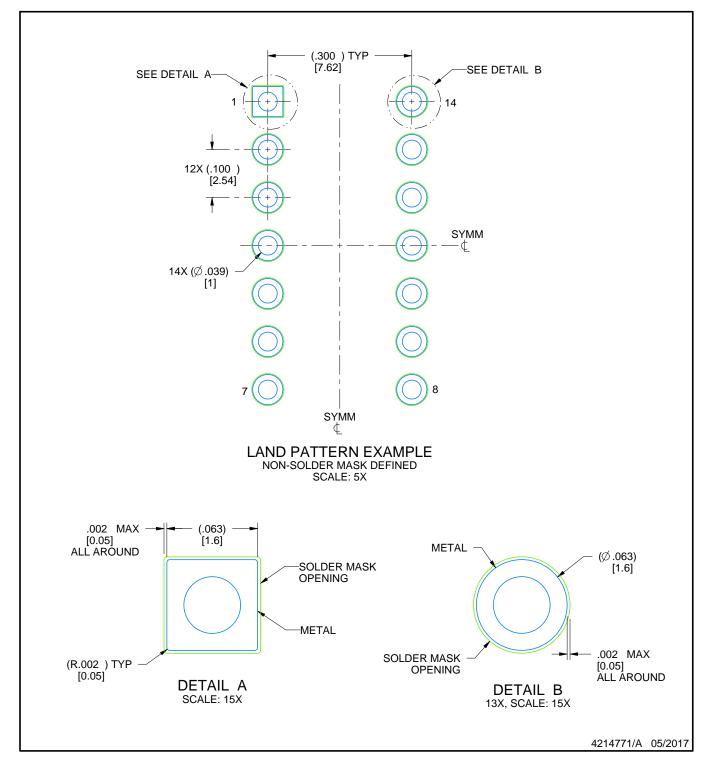


J0014A

EXAMPLE BOARD LAYOUT

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE





D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



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